

● Features:

1. Current transfer ratio (CTR: MIN. 50% at $I_F=5\text{mA}$, $V_{CE}=5\text{V}$)
2. High input-output isolation voltage ($V_{ISO}=5,000\text{Vrms}$)
3. Response time (tr: TYP. $4\mu\text{s}$ at $V_{CE}=2\text{V}$, $I_C=2\text{mA}$, $R_L=100\ \Omega$)
4. Package type:
 - JC817 : dual-in-line package
 - JC817M : wide lead spacing package
 - JC817S : surface mounting package
 - JC817S1 : the other surface mounting package
5. CQC approved
6. UL approved
7. CSA approved

● Description

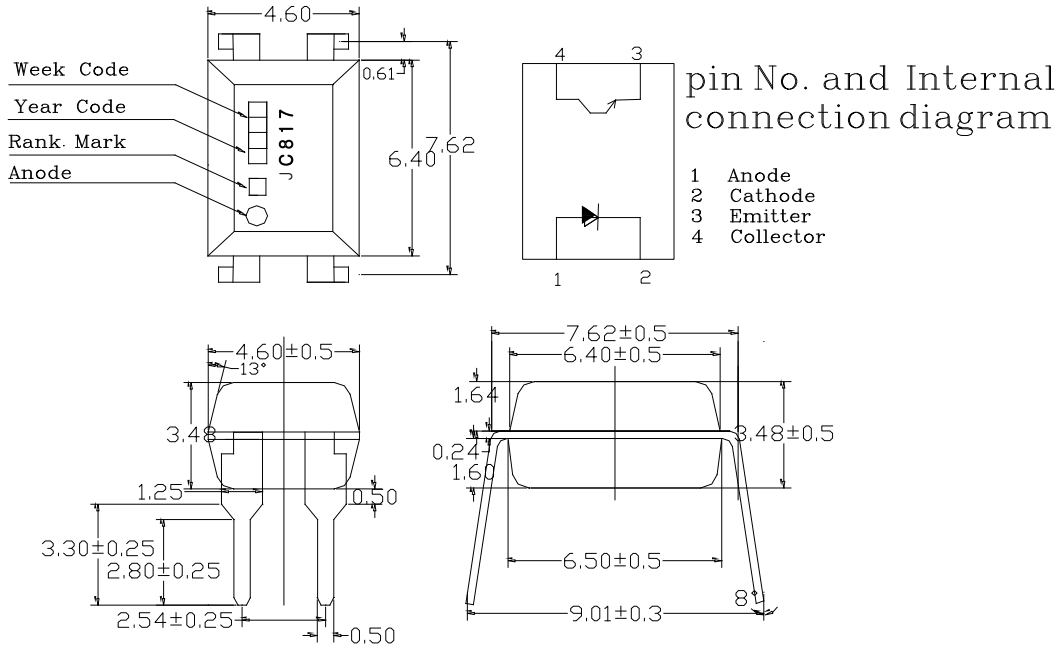
1. The JC817 series are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor
2. The lead pitch is 2.54mm

● Applications:

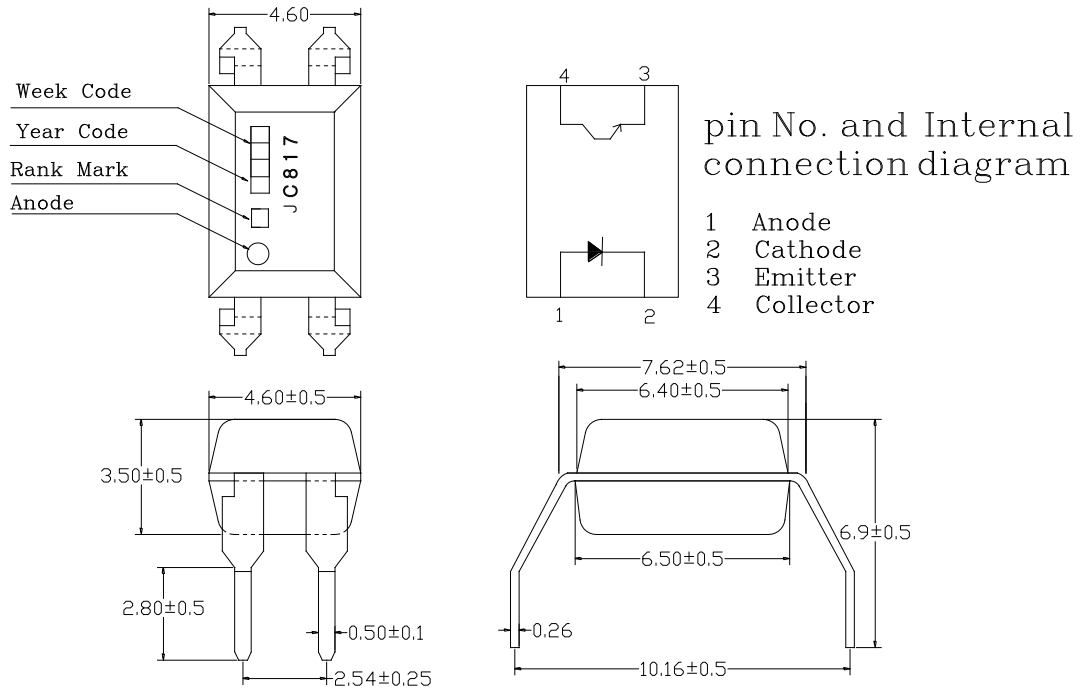
1. Computer terminals.
2. System appliances, measuring instruments.
3. Registers, copiers, automatic vending machines.
4. Electric home appliances, such as fan heaters, etc.
5. Signal transmission between circuits of different potentials and impedances.

● Outline Dimensions

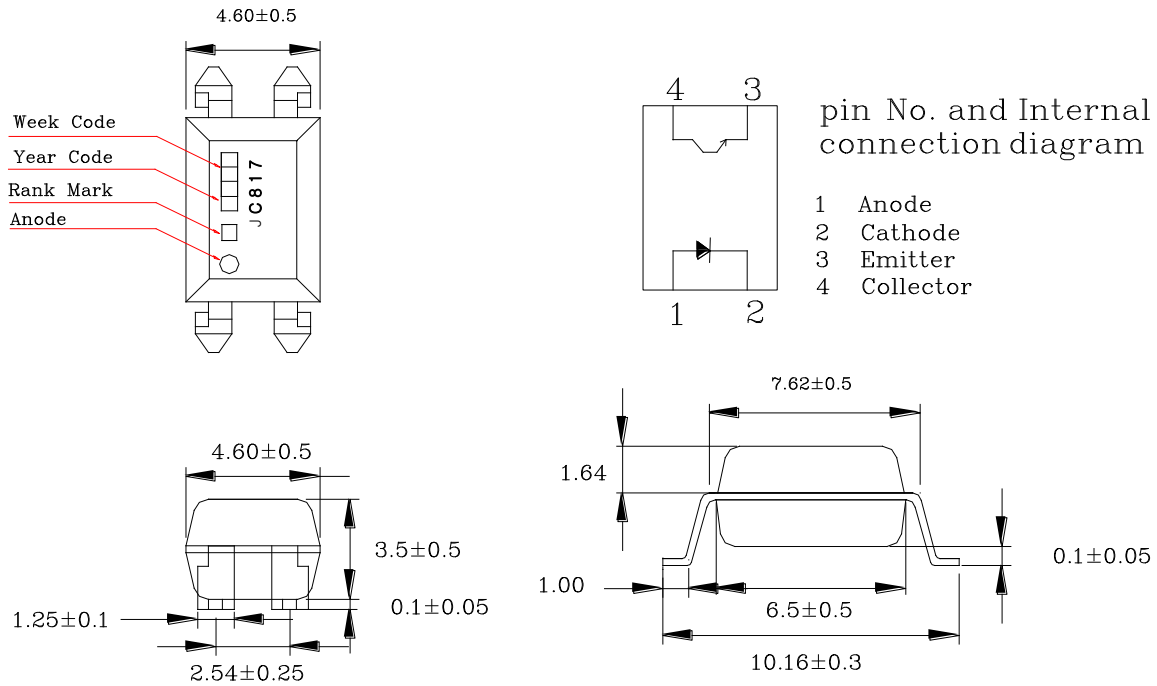
Typical DIP Type



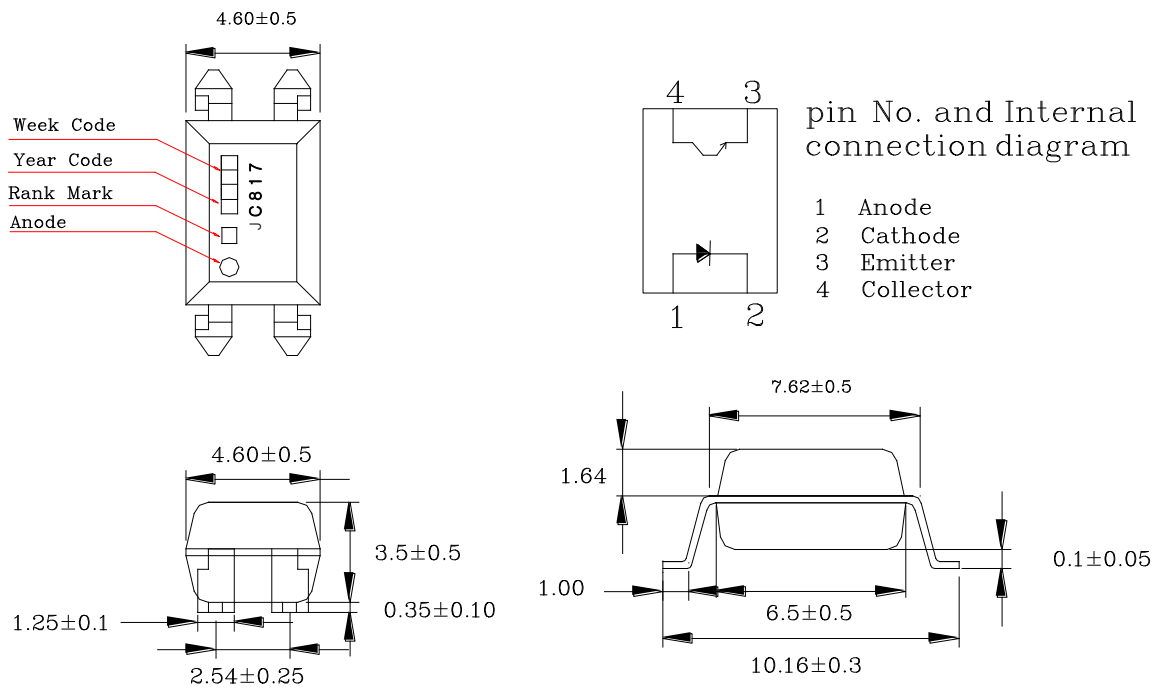
M Type



S Type



S1 Type





● Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
INPUT	Forward Current	I_F	50	mA
	Reverse Voltage	V_R	6	V
	Power Dissipation	P	70	mW
OUTPUT	Collector-Emitter Voltage	V_{CEO}	70	V
	Emitter- Collector Voltage	V_{ECO}	6	
	Collector Current	I_C	50	mA
	Collector Power Dissipation	P_C	150	mW
Total Power Dissipation		P_{tot}	200	mW
*1 Isolation Voltage		V_{iso}	5,000	Vrms
Operating Temperature		T_{opr}	-30 to + 100	°C
Storage Temperature		T_{stg}	-55 to + 125	
*2 Soldering Temperature		T_{sol}	260	

*1. AC for 1 minute, R.H. =40~60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The waveform of applied voltage shall be a sine wave.

*2. For 10 Seconds



JC817 Series

● Electro-Optical Characteristics (Ta=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX	Unit
INPUT	Forward Voltage	V_F	$I_F=20mA$	---	1.2	1.4	V
	Reverse Current	I_R	$V_R=4V$	---	---	10	μA
	Terminal Capacitance	C_t	$V=0, f=1KHz$	---	30	250	pF
OUTPUT	Collector Dark Current	I_{CEO}	$V_{CE}=20V, I_F=0$	---	---	100	nA
	Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C=0.1mA$ $I_F=0$	70	100	---	V
	Emitter-Collector Breakdown Voltage	BV_{ECO}	$I_E=10\mu A$ $I_F=0$	6	9	---	V
	Collector Current 2	I_C	$I_F=5mA$	2.5	---	30	mA
	*2 Current Transfer Ratio 2	CTR	$V_{CE}=5V$	50	---	600	%
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F=20mA$ $I_C=1mA$	---	0.1	0.2	V
	Isolation Resistance	R_{iso}	DC500V 40~60%R.H.	5×10^{10}	1×10^{11}	---	Ω
	Floating Capacitance	C_f	$V=0, f=1MHz$	---	0.6	1	pF
	Cut-Off Frequency	f_c	$V_{CE}=5V,$ $I_C=2mA$ $R_L=100\Omega,$ -3dB	---	80	---	kHz
	Response Time(Rise)	t_r	$V_{CE}=2V,$ $I_C=2mA$	---	4	18	μs
	Response Time(Fall)	t_f	$R_L=100\Omega$	---	3	18	μs

*1 □ CTR = $I_C / I_F \times 100\%$

● Rank Table Of Current Transfer Ratio(CTR)

RANK MARK	Min. (%)	Max. (%)
L	50	100
A	80	160
B	130	260
C	200	400
D	300	600
L or A or B or C or D	50	600

Notes: 1. Conditions: $I_F=5mA, V_{CE}=5V, Ta=25^\circ C$.

● Characteristics Curves

Fig.1 Forward Current vs. Ambient Temperature

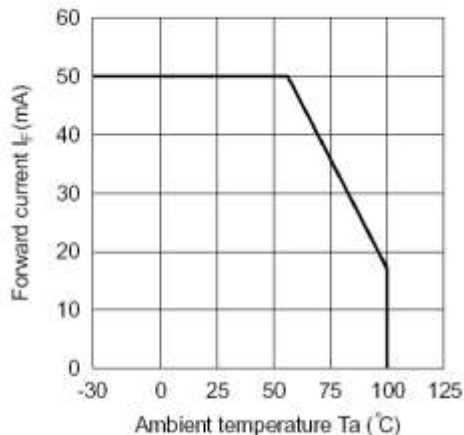


Fig.2 Collector Power Dissipation vs. Ambient Temperature

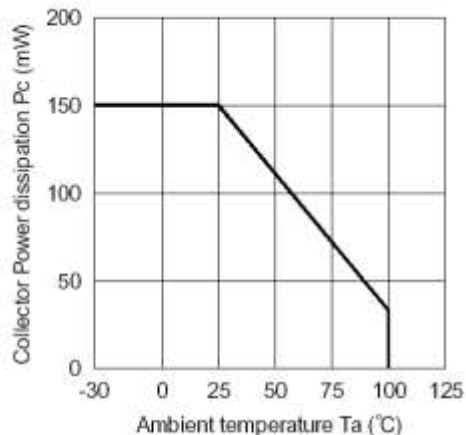


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

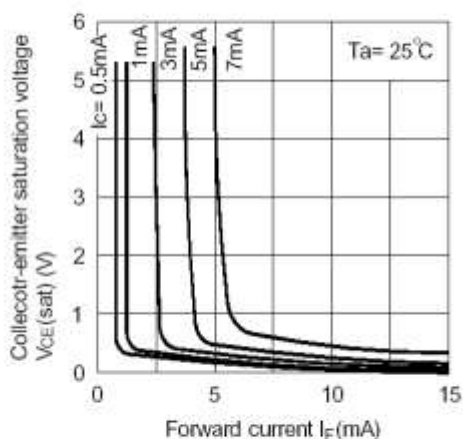


Fig.4 Forward Current vs. Forward Voltage

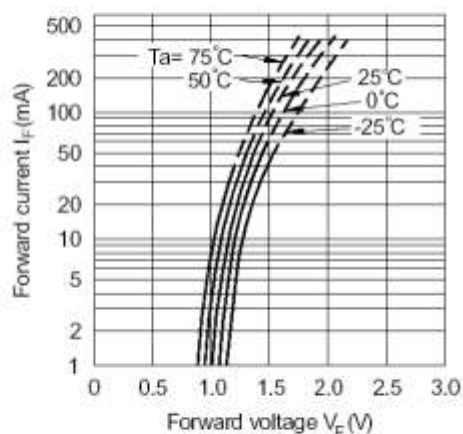


Fig.5 Current Transfer Ratio vs. Forward Current

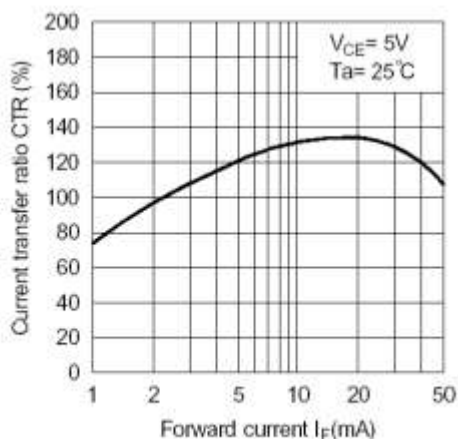
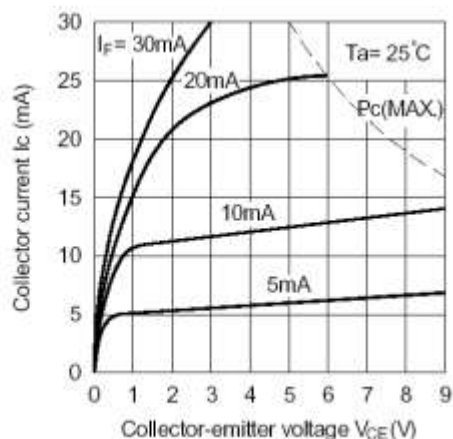


Fig.6 Collector Current vs. Collector-emitter Voltage



● Characteristics Curves

Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

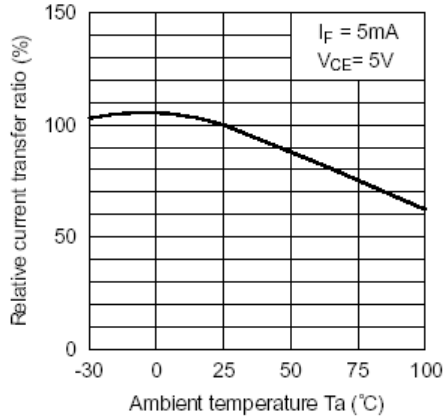


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

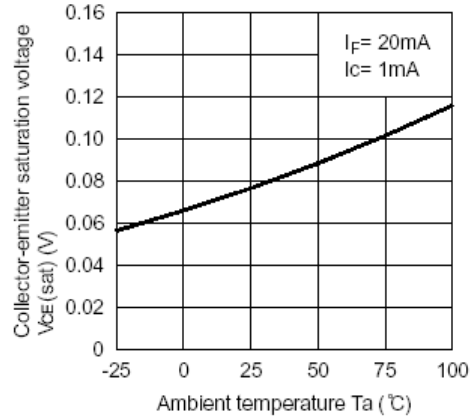


Fig.9 Collector Dark Current vs. Ambient Temperature

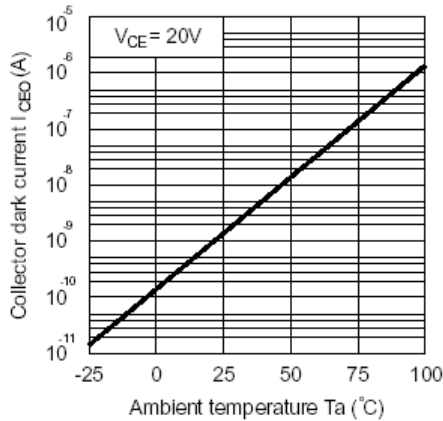


Fig.10 Response Time vs. Load Resistance

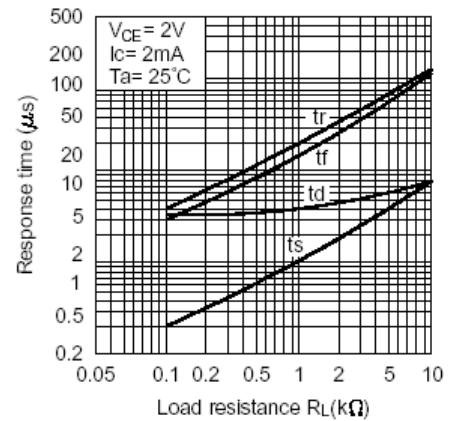
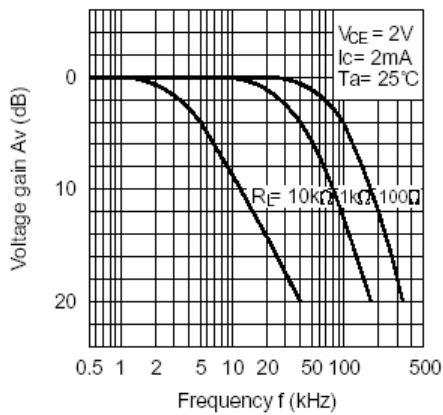
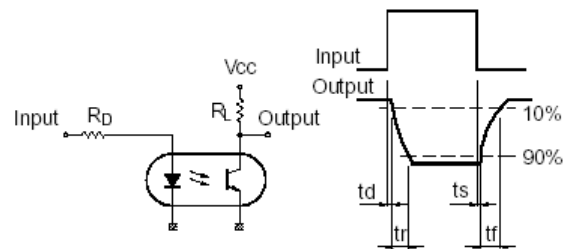


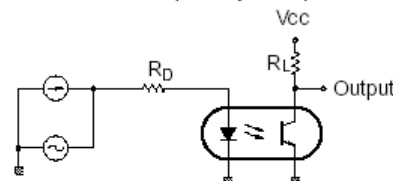
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



● Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS C 7021 :B-1	Connect with a power $I_f=50\text{mA}$ T_a =Under room temperature Test time=1,000hrs	0/20
	High Temperature High Humidity Reverse Bias (H3TRB)	JIS C 7021 :B-11	$T_a=+85^\circ\text{C}\pm 5^\circ\text{C}$, RH=85% PTR= V_{CE} absolute max rating*80% Test time=1000hrs	0/20
	High Temperature Reverse Bias (HTRB)	JIS C 7021 :B- 8	$T_a=+105^\circ\text{C}\pm 5^\circ\text{C}$ PTR= V_{CE} absolute max rating Test time=1000hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS C 7021 :B-10	High $T_a=+125^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low $T_a=-55^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1,000hrs	0/20
	Autoclave	JESD 22-A102-B	P=15PSIG, $T_a=121^\circ\text{C}$ Humi. =100%RH, 48hrs	0/20
	Environmental Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS C 7021 :A-4	$125^\circ\text{C} \sim 25^\circ\text{C} \sim -55^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min Test Time=20cycle
Thermal Shock		MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	$125^\circ\text{C} \sim -55^\circ\text{C}$ 20min 20min Test Time=20cycle	0/20
Solder Resistance		MIL-STD-202:201A MIL-STD-750:2031 JIS C 7021 :A-1	Operation heating : 260°C , within 10 ± 1 seconds.	0/20
Solder Ability		MIL-S-883:2003 JIS C 7021 :A-2	Operation heating : 235°C , within 5 ± 1 seconds.	0/20

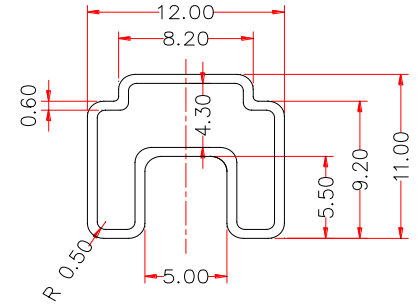
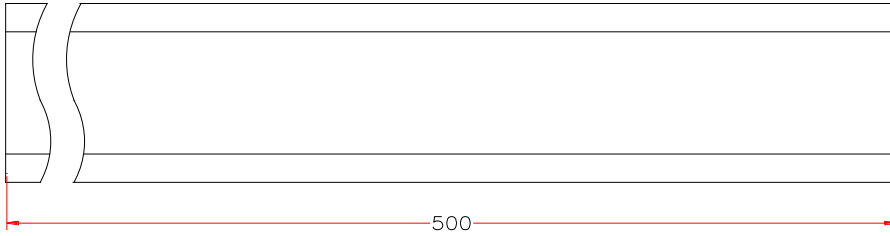
● Judgment Criteria Of Failure For The Reliability

Symbol	Measuring conditions	Judgment criteria for failure
V_F (V)	$I_f=50\text{mA}$	Over $U \times 1.0$
I_r (uA)	$V_r=5\text{V}$	Over $U \times 1.0$
CTR(%)	$I_f=5\text{mA}$, $V_{CE}=5\text{V}$	Shift > 1.2
$V_{CE(sat)}$	$I_F=20\text{mA}$, $I_C=1\text{mA}$	Over $U \times 1.0$
BV_{CEO}	$I_C=0.1\text{mA}$, $I_F=0$	Over $L \times 1.0$
BV_{ECO}	$I_E=10\mu\text{A}$, $I_F=0$	Over $L \times 1.0$

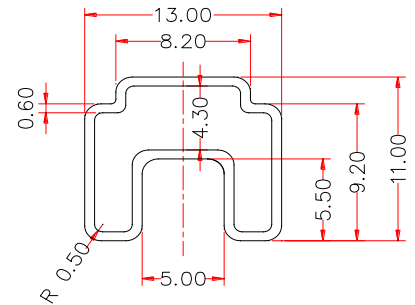
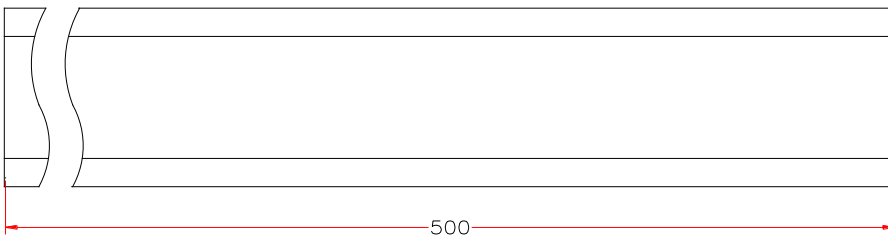
● Packaging

1. Tube Packing(For Dip & M Type)

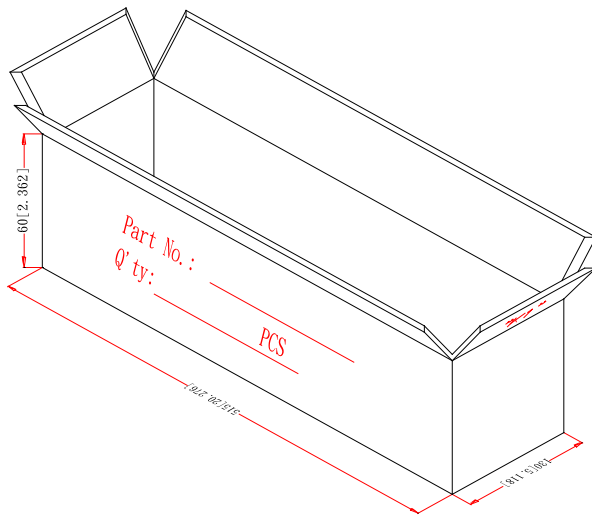
A. Dimensions of tube for dip type(Units: mm)



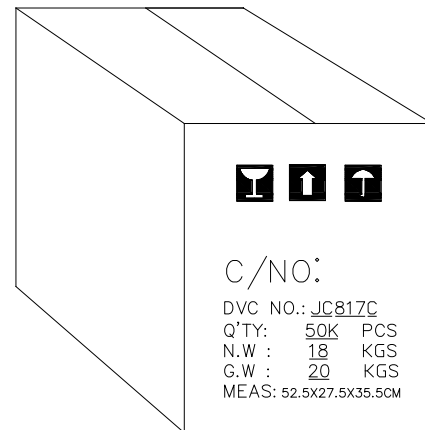
B. Dimensions of tube for M type(Units: mm)



C. Inner Carton (Units: mm)



D. Outside Carton(Units: mm)



E. Packing Quantity

100 pcs per Tube;

50 Tube per Inner Carton for Dip Type;

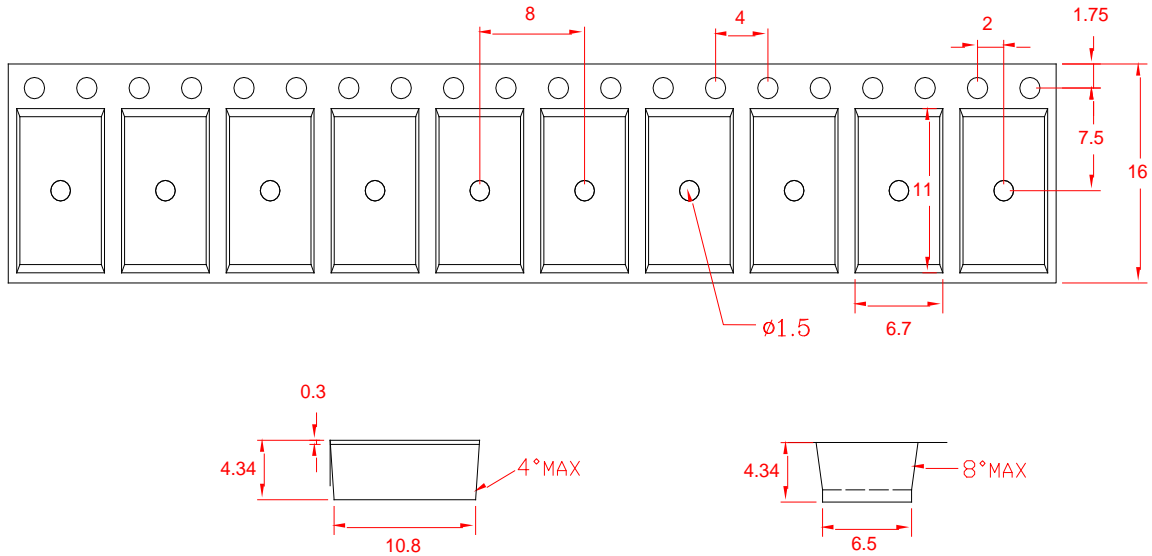
45 Tube per Inner Carton for M Type;

10 Inner Carton per Outside Carton

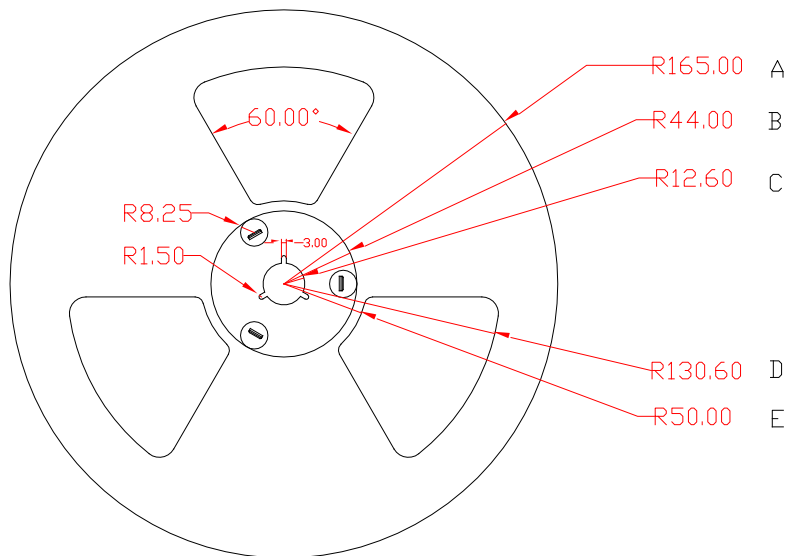
□ Packaging

2. Tape & Reel Packing (for S & S1 Type)

A. Dimensions of Reel



B. Dimensions of Tape



C. Packing Quantity

2 Kpcs per Reel;

1 Reel per Inner Carton;

10 Inner Carton per Outside Carton